



MLP32-55 SIC40x Wire Bond and Epoxy Changes

DESCRIPTION OF CHANGE: Vishay Siliconix is standardizing the assembly for all MLP BWL products in order to improve cycle times, lead-times and increase production capacity. The MLP32-55 products SIC40x are now qualified with same materials as Vishay latest MLP parts. The changes are:

- No BSOB (Ball Stich On Ball) on lead post (change from BSOB Wire Bond)
- Nonconductive epoxy for IC Die Attach (change from conductive epoxy)

CLASSIFICATION OF CHANGE: Direct Material

REASON FOR CHANGE: Cycle time Improvement and capacity increase

EXPECTED INFLUENCE ON PERFORMANCE/QUALITY/RELIABILITY: There will be no effect on performance, quality or reliability.

PRODUCT CATAGORY: ICs

PART NUMBERS AFFECTED:

PRD402BCD-T1-GE3	SIC401ACD-T1-GE3	SIC402ACD-T1-GE3	SIC403ACD-T1-GE3
PRD403ACD-T1-GE3	SIC401BCD-T1-GE3	SIC402BCD-T1-GE3	SIC403BCD-T1-GE3

VISHAY BRAND(s): Vishay-Siliconix

TIME SCHEDULE: Shipment of products will begin December 11, 2017

SAMPLE AVAILABILITY: Please contact your regional Vishay Sales office for sample availability.

QUALIFICATION DATA: Additional data available upon request.

This PCN is for notification purposes only. Your response is not required. If you have any questions, please contact your local Vishay Sales Office.

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